## Heraeus

## **Technical Data Sheet**



# **ASSEMBLY MATERIALS**

Product Type: No Clean Solder Paste

Product Name: F640 SAC305-89M30

## Description

The Heraeus F640 Paste Series is a lead free, no clean solder paste with outstanding wetting performance for a broad range of applications. The flux system is specifically optimized for lead free alloys, e.g. Sn/Ag/Cu. This formula provides superior performance on a variety of surface finishes and leaves behind a clear residue.

## Key Benefits

- Outstanding wetting
- Exceptional print to print consistency
- Min. 8 hours tack and work life
- Siemens Norm compliant

## **Compliant Products**

- Flux SF 64
- Solder Wire W640

## Applications

Printing

## **Product Code and Alloy**

Product Code				Powder Properties			
Paste	Alloy	Metal Content	*Viscosity	Powder Type	Particle Size	Alloy	Melting Point
F640	SAC305	89%	М	3	25 – 45 μm	Sn96.5/Ag3/Cu0.5	217 °C

 $<sup>^*</sup>D = Dispense \ grade \quad M = Print \ grade \quad H = Print \ grade, \ high \quad L = Dipping/Jetting \ grade, \ Low$ 

Flux Activity		
Activity Level (J-STD 004)	ISO 9454-1 {DIN EN 29454-1}	Classification
RELO	1.2.2.C	No Clean/ Solvent Clean

## Halogen Content

## **Halogen-Containing**

Tolerances: CI or Br > 900 ppm, total > 1500 ppm; measured according to BS EN 14582

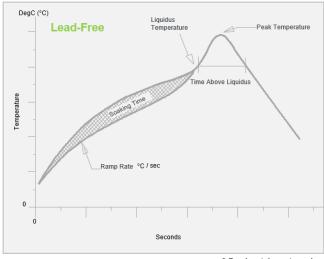
## Testing

Copper Mirror Test (J-STD 004)	Silver Chromate Test (J-STD 004)
(3-312 004)	(3-310 004)
Passed	Passed
Copper Plate Corrosion Test (J-STD 004)	Surface Insulation Resistance (SIR) Test (J-STD 004) (Bellcore GR78)
Passed	Passed



## **Technical Data Sheet**

## **Recommended Reflow Profile**



*	Graph	not	drawn	to	scal	É

Recommended Profile		
Average Ramp Rate	1 – 3 °C/s	
	15 °C (min) –	
Peak Temperature	40 °C (max)	
	above Melting	
	Temperature	
Time above liquidus	45 – 90 s	
	Reflow in Air	
Reflow Atmosphere	or in N <sub>2</sub> with	
Type 3 – 5	< 2000 ppm 0 <sub>2</sub>	

The descriptions and engineering data shown here have been compiled by Heraeus using commonly-accepted procedures, in conjunction with modern testing equipment, and have been compiled as according to the latest factual knowledge in our possession. The information was up-to date on the date this document was printed (latest versions can always be supplied upon request). Although the data is considered accurate, we cannot guarantee accuracy, the results obtained from its use, or any patent infringement resulting from its use (unless this is contractually and explicitly agreed in writing, in advance). The data is supplied on the condition that the user shall conduct tests to determine materials suitability for a particular application)

## **Cleaning Instructions**

After reflow flux residues may remain on the circuit and do not need to be washed. For cleaning of wet paste or if desired for cleaning of flux residues Zestron and Vigon cleaners can be used – see separate cleaning recommendations.

## Storage

- Store the solder paste in tightly-sealed containers and avoid exposure to sunlight and high humidity
- Max expiration date: please refer to the expiry date on the label of the packaged product
- Storage condition in the refrigerator at 2 -
- Store cartridges with tip pointing downwards

## Paste Preparation

- Remove paste from fridge: Before opening the package, leave paste for at least 4 hours (depending on jar/ cartridge size) at room temperature, so that paste warms up
- Do not open jar/cartridge while paste is cold to prevent condensation
- Do not heat the paste beyond room temperature
- Before using of paste jar: To obtain uniform, stable viscosity stir paste for 1 to 2 min, using a stainless steel or chemically resistive plastic spatula
- For further information see Technical Information

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